UTC UNISONIC TECHNOLOGIES CO., LTD

1N60-TA **Preliminary Power MOSFET**

1.0A, 600V N-CHANNEL POWER MOSFET

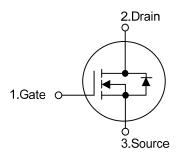
DESCRIPTION

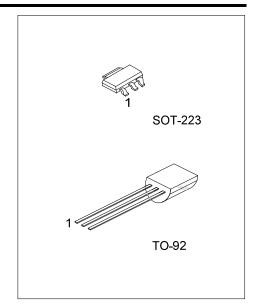
The UTC 1N60-TA is a high voltage MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

FEATURES

- * $R_{DS(ON)}$ < 15 Ω @ V_{GS} =10V, I_D =0.5A
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

SYMBOL

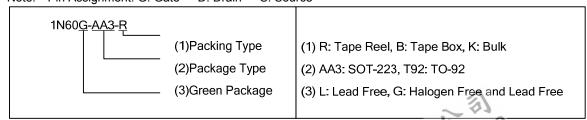




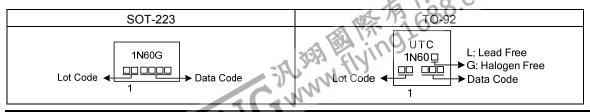
ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
-	1N60G-AA3-R	SOT-223	G	D	S	Tape Reel	
1N60L-T92-B	1N60G-T92-B	TO-92	G	D	S	Tape Box	
1N60L-T92-K	1N60G-T92-K	TO-92	G	D	S	Bulk	

Note: Pin Assignment: G: Gate S: Source D: Drain



MARKING



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ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	600	V
Gate-Source Voltage		V_{GSS}	± 30	V
Drain Current	Continuous	I _D	1.0	Α
	Pulsed (Note 2)	I_{DM}	4.0	Α
Avalanche Current (Note 2)		I _{AR}	1.1	Α
Avalanche Energy Single Pulsed (Note 3)		E _{AS}	6	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.6	V/ns
Power Dissipation	SOT-223	D	8	W
	TO-92	P_{D}	1	W
Junction Temperature		T _J	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 10mH, I_{AS} = 1.1A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}$ C
- 4. $I_{SD} \le 1A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	SOT-223	0	150	°C/W
	TO-92	θ_{JA}	140	°C/W
Junction to Case	SOT-223	0	15.6	°C/W
	TO-92	θ_{JC}	125	°C/W



ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified.)

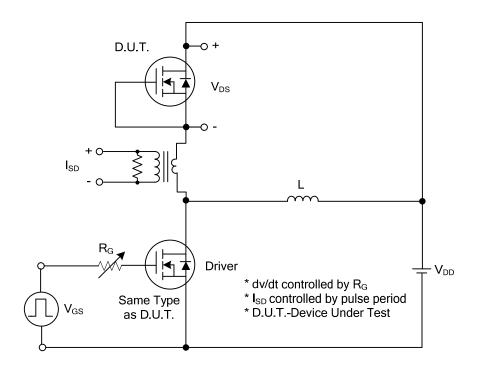
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS						ı		
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250μA	600			V	
Drain-Source Leakage Current		I _{DSS}	V _{DS} =600V, V _{GS} =0V			10	μA	
Gate-Source Leakage Current	Forward	GSS	V_{GS} =30V, V_{DS} =0V			100	nA	
	Reverse		V_{GS} =-30V, V_{DS} =0V			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.0		4.0	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	V_{GS} =10V, I_D =0.5A			15	Ω	
DYNAMIC CHARACTERISTICS								
Input Capacitance	Input Capacitance				95		pF	
Output Capacitance		Coss	V_{DS} =25V, V_{GS} =0V, f=1MHz		15		pF	
Reverse Transfer Capacitance		C_{RSS}			3.5		pF	
SWITCHING CHARACTERISTIC	S							
Total Gate Charge (Note 1)		Q_G	V _{DS} =50V, V _{GS} =10V, I _D =1.3A,		9		nC	
Gate to Source Charge		Q_{GS}	I_{G} =100µA (Note 2,3)		1.5		nC	
Gate to Drain Charge		Q_{GD}	IG-100μΑ (140tc 2,3)		1.3		nC	
Turn-ON Delay Time (Note 1)		t _{D(ON)}			30		ns	
Rise Time		t_R	V_{DD} =30V, V_{GS} =10V, I_{D} =0.5A,		25		ns	
Turn-OFF Delay Time		t _{D(OFF)}	R_G =25 Ω (Note 2,3)		40		ns	
Fall-Time		t_{F}			25		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuous	Current	I _S				1	Α	
Maximum Body-Diode Pulsed Cur	rent	I _{SM}				4	Α	
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =1.0A, V _{GS} =0V			1.4	V	
Reverse Recovery Time (Note 1)		t _{rr}	I _S =1.0A, V _{GS} =0V,		330		nS	
Reverse Recovery Charge		Q_{rr}	dI _F / dt =100A/μs		600		nC	

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature.

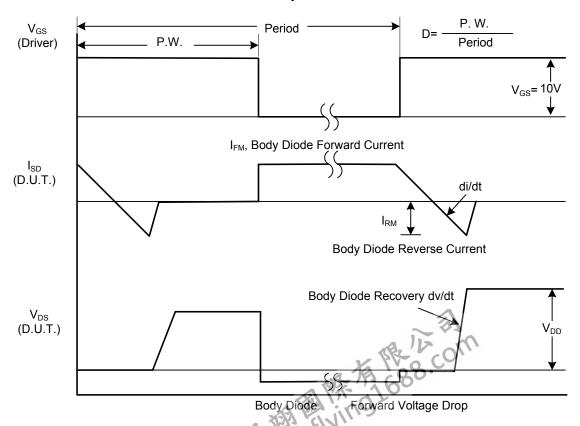
- 2. Pulse Test: Pulse Width ≤300µs, Duty Cycle≤2%.
- 3. Essentially Independent of Operating Temperature.



TEST CIRCUITS AND WAVEFORMS

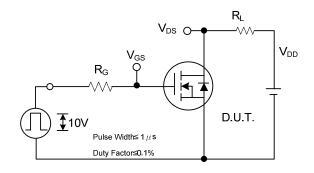


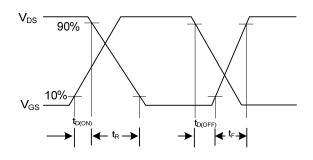
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

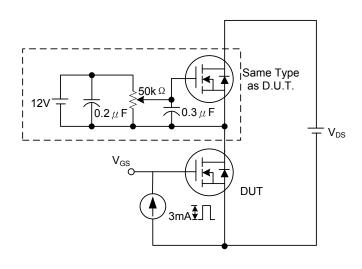
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

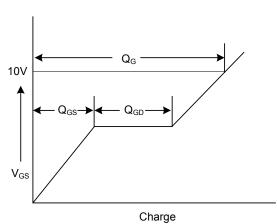




Switching Test Circuit

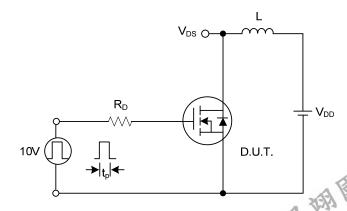
Switching Waveforms

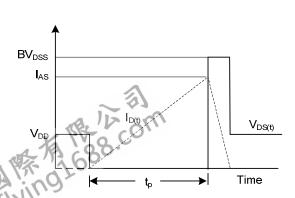




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms



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